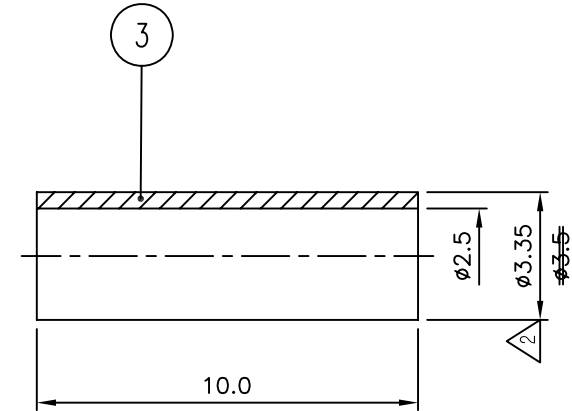
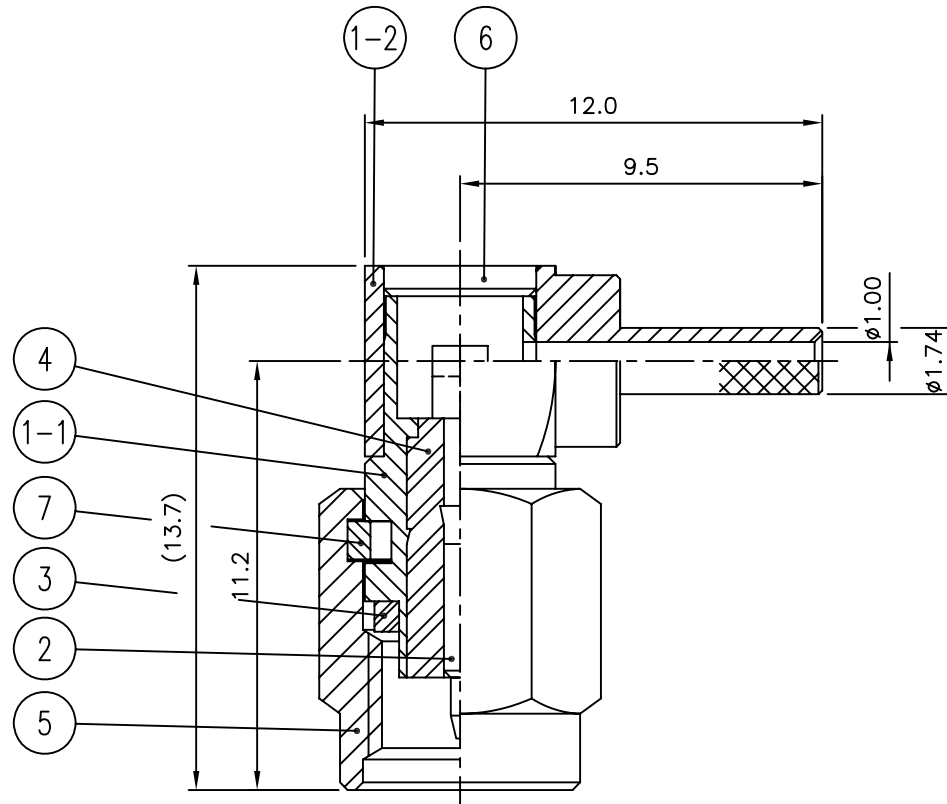


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration			2008.01.10.
1	[설번처리No.201201-0007] (조립성으로 인해 GASKET 변경 및 BODY 구조 변경)	I.C.KIM	J.H.YOUN	2012.01.25.
2	[설번No.202201-0009] PIPE 압착 후 BURR 발생 개선을 위한 PIPE 변경	S.Y.EUN	S.H.KIM	2022.01.18.



8	SPRING RING	1	BeCu	Gold Plate	DSR00003-5/1
7	COVER	1	MBsBD	Gold Plate	DCO00015-5/1
6	CAP	1	SUS	부동태 처리	DCU00137-5/1
5	INSULATOR	1	TEFLON		DIN01335-N/1
4	GASKET	1	SILICONE RUB		DGK00003-N/2 DGK00003-N/1
3	FERRULE	1	MBsBD	Nickel Plate Gold Plate	DFE00018-5/2 DFE00018-5/1
2	CONTACT	1	MBsBD	Gold Plate	DCT00295-5/1
1-2	BODY	1	MBsBD	Gold Plate	DBD03011-3/1 DBB00020-5/2 DBD01754-3/1
1-1	BODY	1	MBsBD	Gold Plate	DBB00020-5/1 DBD02088-3/2 DBD00101-3/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2022. 01. 18.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	S.H.KIM		
	$\pm 1^{\circ}$	CHECKED BY			
MATERIAL		DRAWN BY	S.Y.EUN		TITLE SSMA50 CABLE PL 178
FINISH		SCALE 5/1	UNIT mm		
					DWG NO. CN02025-7/2
					REVISION 2 SHEET 1 of 1